

Industrial AI - Best Practices in Semiconductor Manufacturing

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Today

1 Why Industrial AI?

2 ML for Computer vision applications in manufacturing

3 ML for Time-series applications in manufacturing

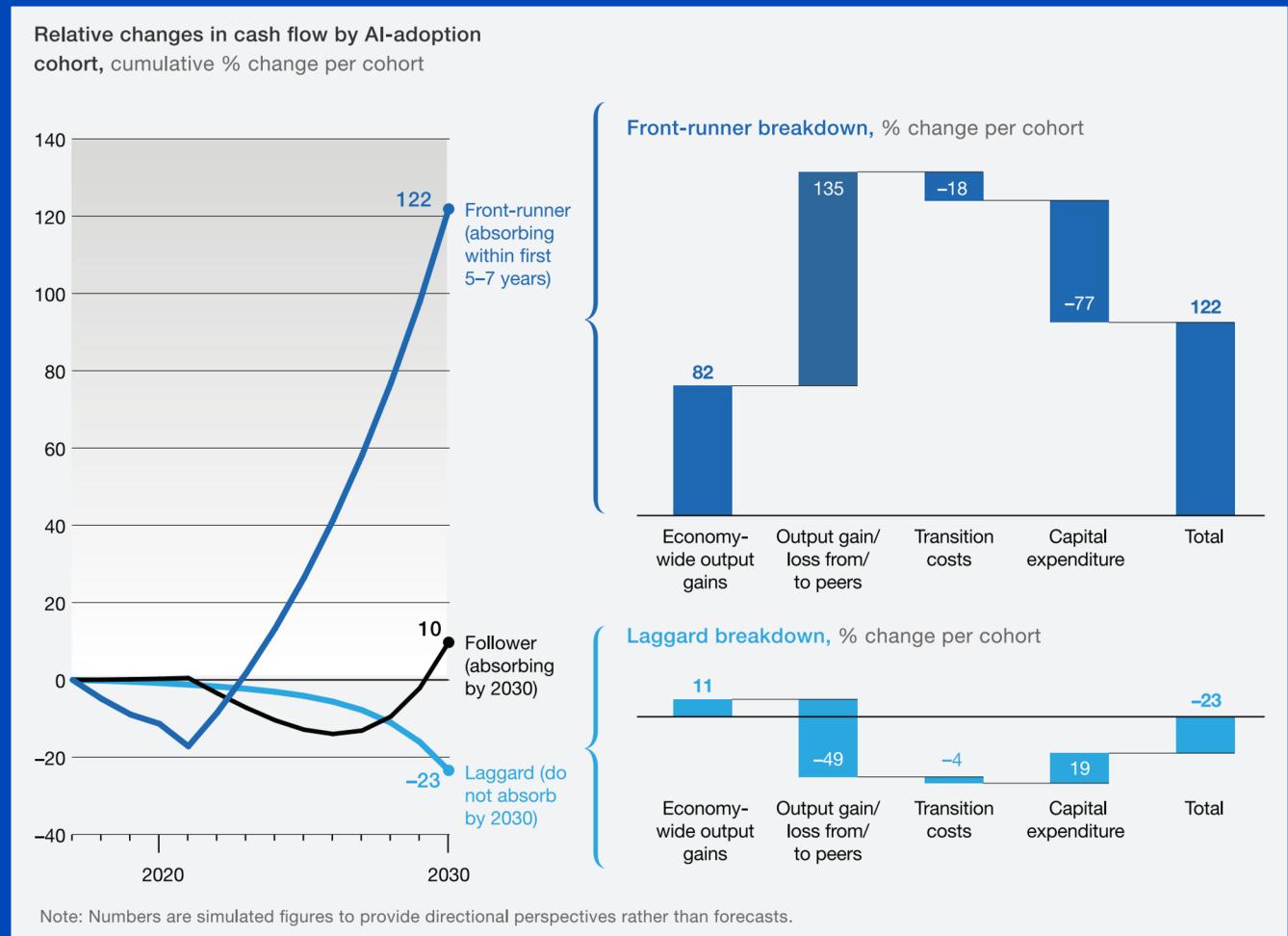
4 Difficulties with time-series ML in manufacturing

5 Manufacturing AI success story - Virtual Metrology

Why Industrial AI?

Fast AI adoption creates **LARGER** economic gains

- change in cash flow by 2030
 - front-runner - +122%
 - follower - +10 %
 - laggard - -23%

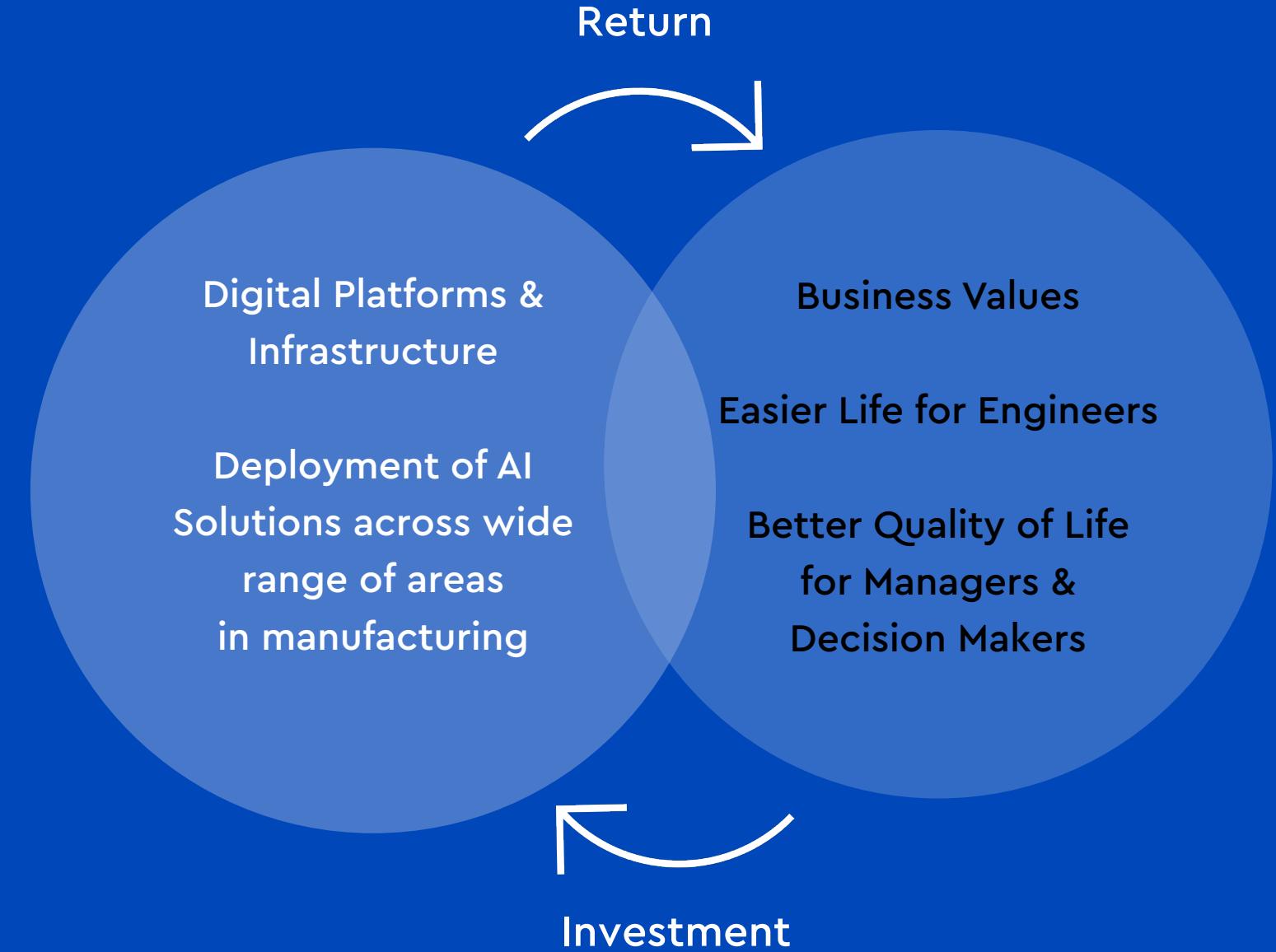


* Source: McKinsey Global Institute Analysis (2019)

Data Characteristics

Virtuous (or Vicious) Cycle

Data-centric AI



"We need 1,000 models for 1,000 problems" – Andrew Ng

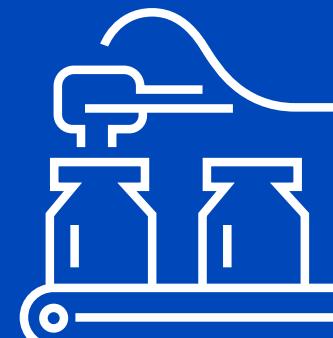
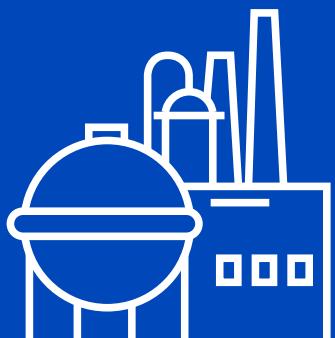
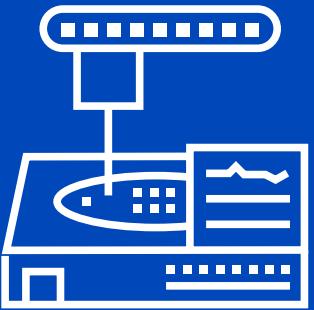
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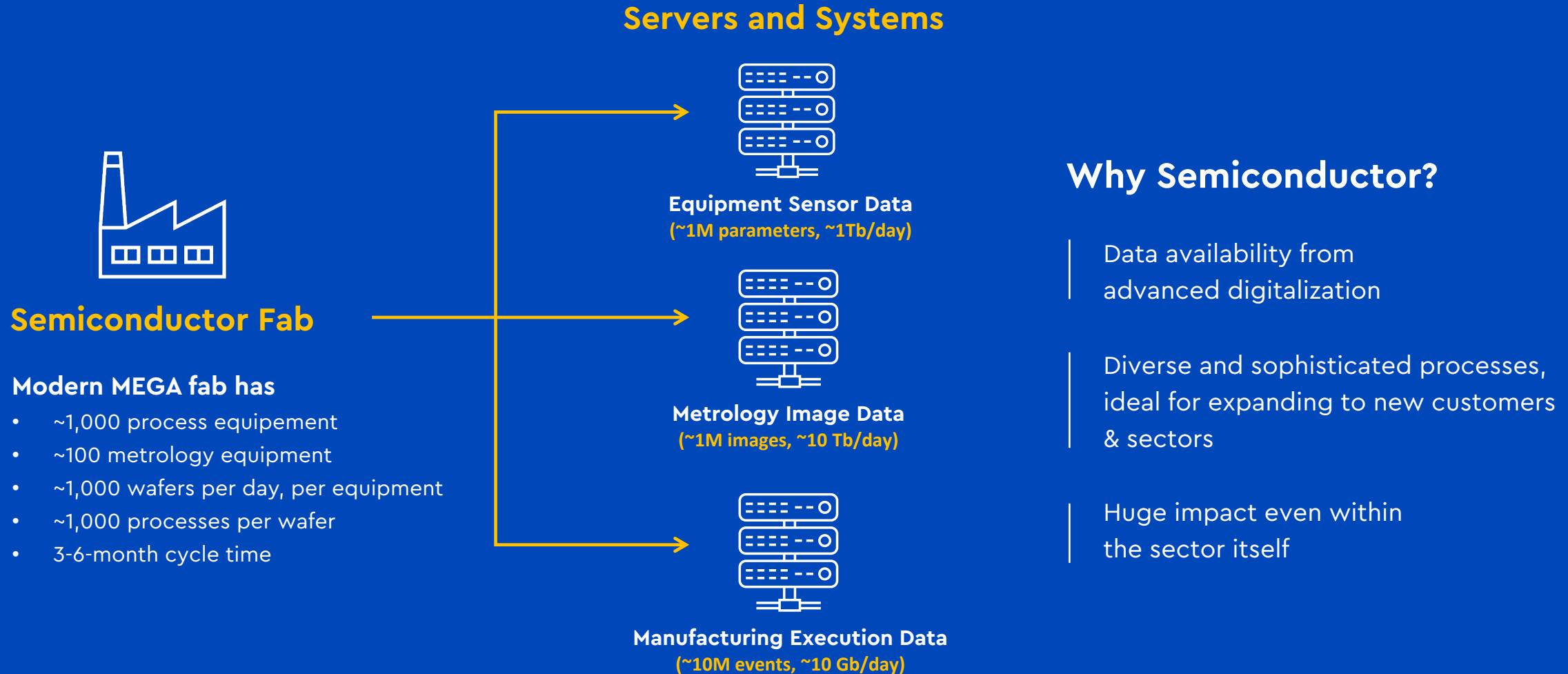
Data-centric AI

Discipline of systematically engineering the data used to build an AI system



Every company or sector has its own problems

Semiconductor is Great Starting Point!



Difficulties

Data Characteristics

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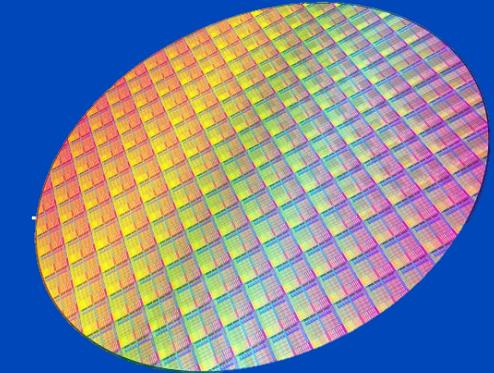


Computer vision and time-series ML in Manufacturing

Huge amount of image data to measure and inspect

Scanning electron microscope (SEM) images, transmission electron microscope (TEM) images, etc.

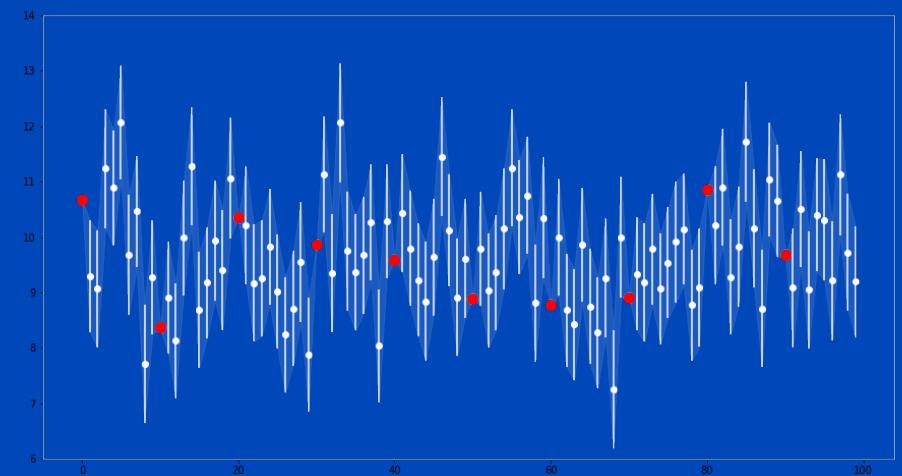
→ pattern classification, defect inspection, anomaly detection, etc.



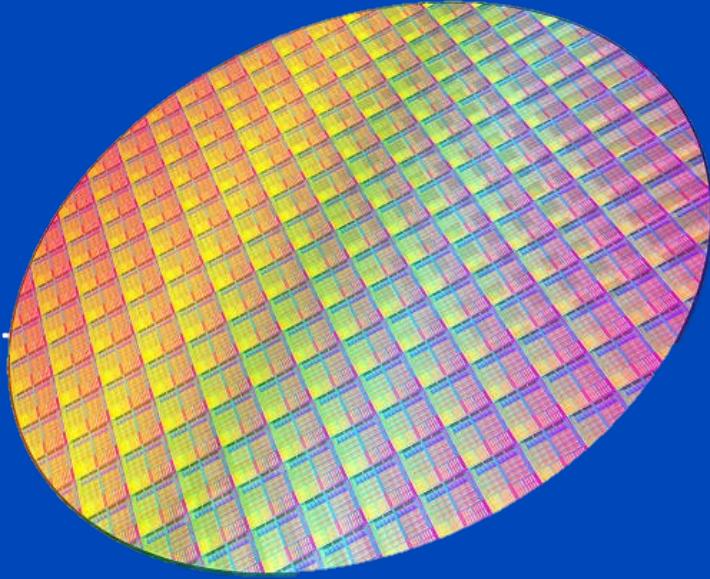
Almost all data coming from manufacturing - time-series data

sensor data, process times, measurement, MES data

→ time-series ML – semi-supervised learning, (variational) Bayesian inference, anomaly detection



Computer Vision ML for manufacturing



Metrology

Measurement of critical features

Inspection

Defect Inspection

Defect localization and classification

Image courtesy of ASML

Scanning Electron Microscope

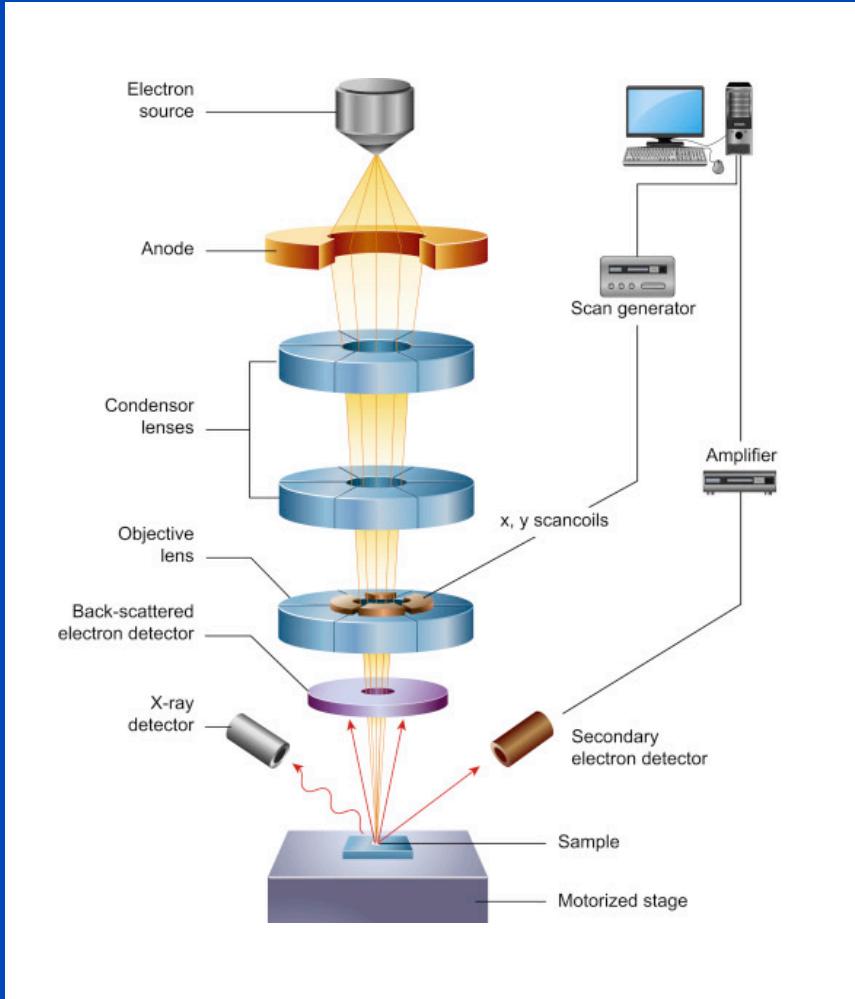
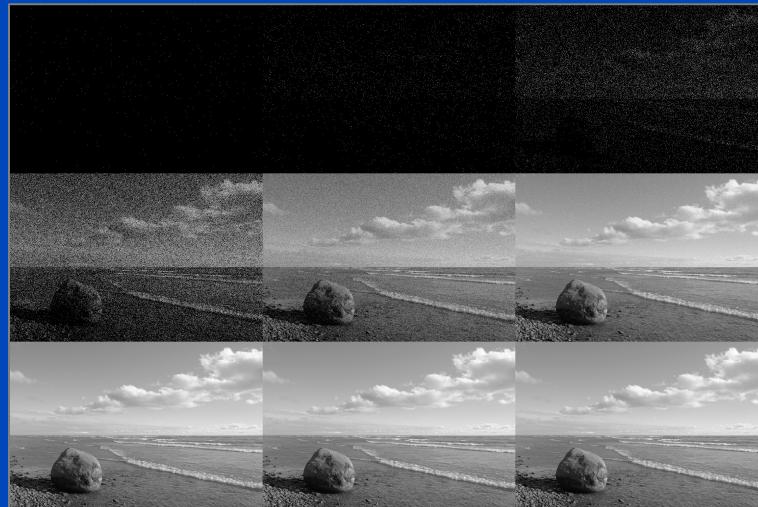
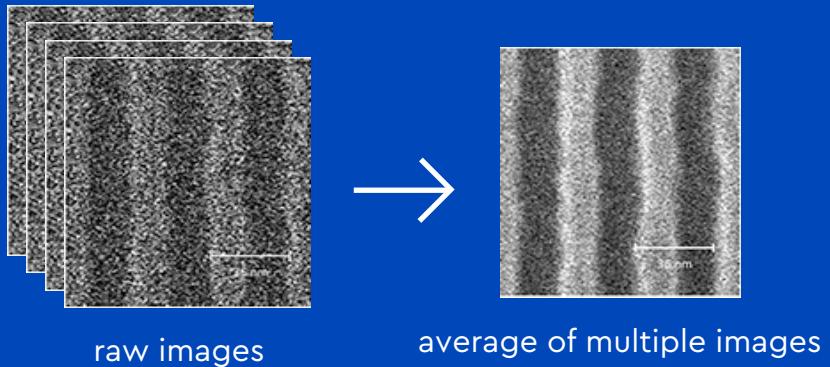


Image courtesy of <https://www.sciencedirect.com/science/article/pii/B078008100040300002X>



Shot Noise Image courtesy of https://en.wikipedia.org/wiki/Shot_noise

Image restoration

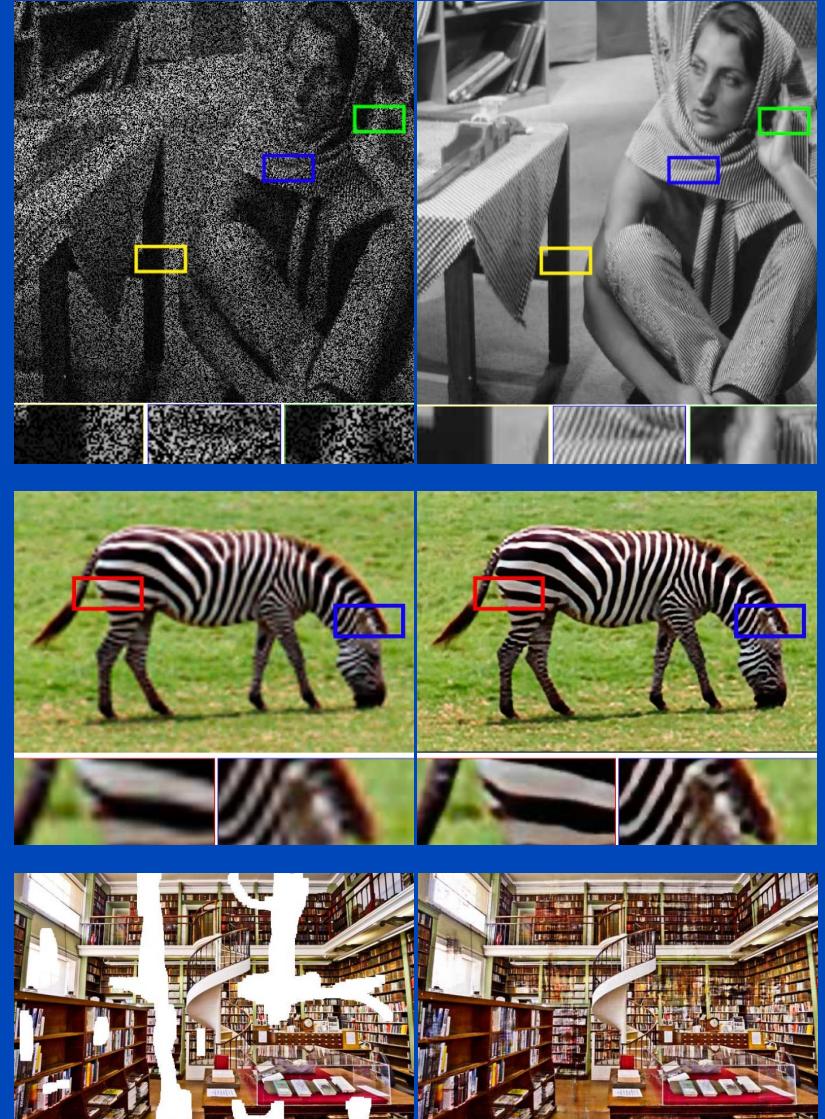
Inverse problem of image corruption

$$x = f(y) + n$$

- y: clean image
- x: corrupted image
- n: noise

$f(\cdot)$ & corresponding solutions

- Noising: Identity function → Denoising
- Downsampling → Super-resolution
- Missing pixels → Inpainting

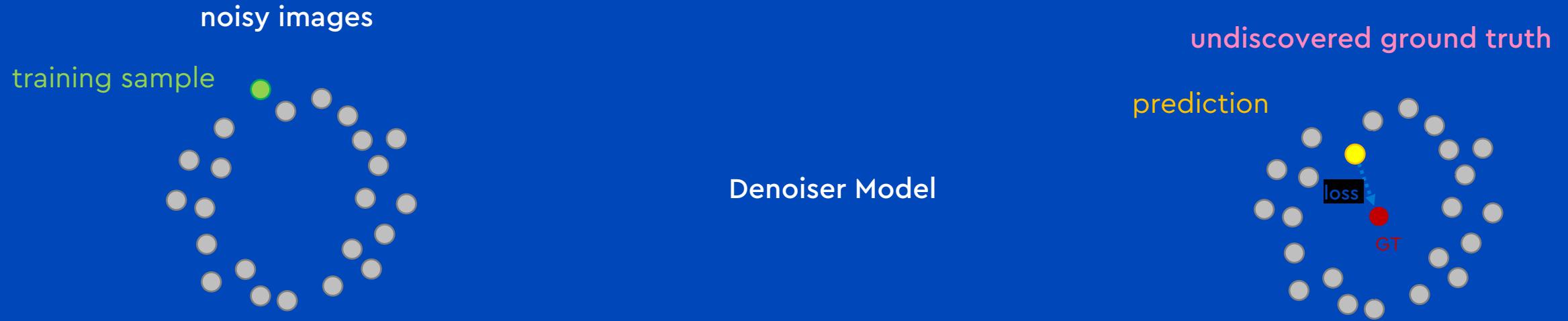


Supervised image denoising



However, NOT possible to acquire ground-truth in practice.

Blind denoising without ground truth



assuming mean of noise zero, averages of gradients, or equivalently, gradients of averages, surrogates for ground truth

Information containment perspective, noise generating filter does not erase perfectly ground truth!

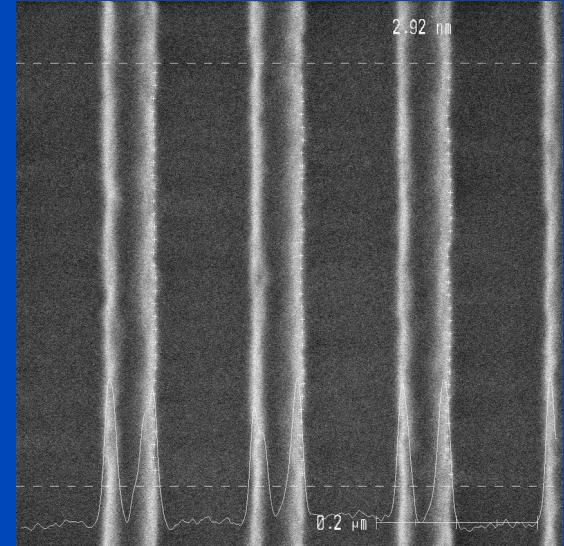
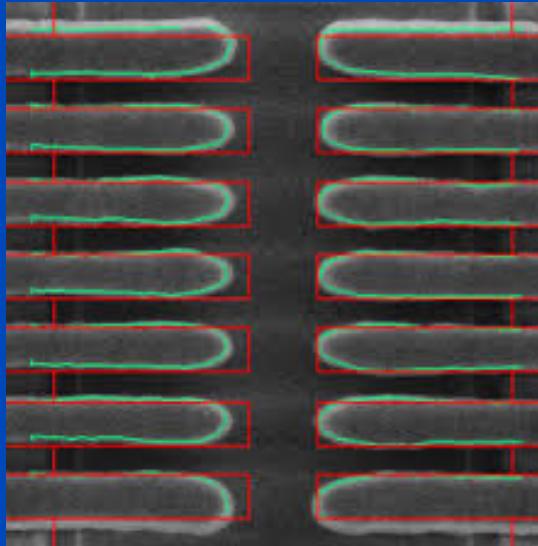
Metrology based on segmentation and pattern recognition

Investment

Automatic measurement of critical dimensions

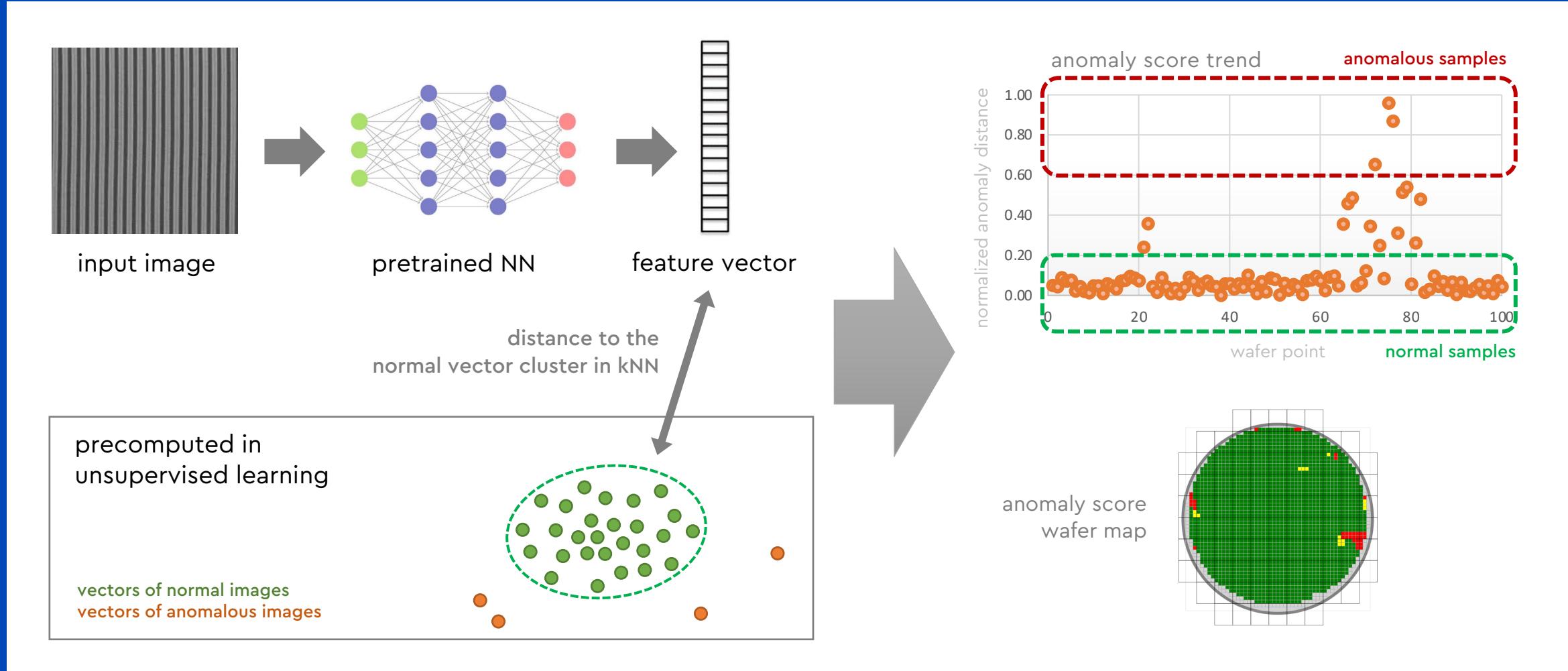
Approaches

- Texture segmentation
- Repetitive pattern recognition
- Automatic measurement

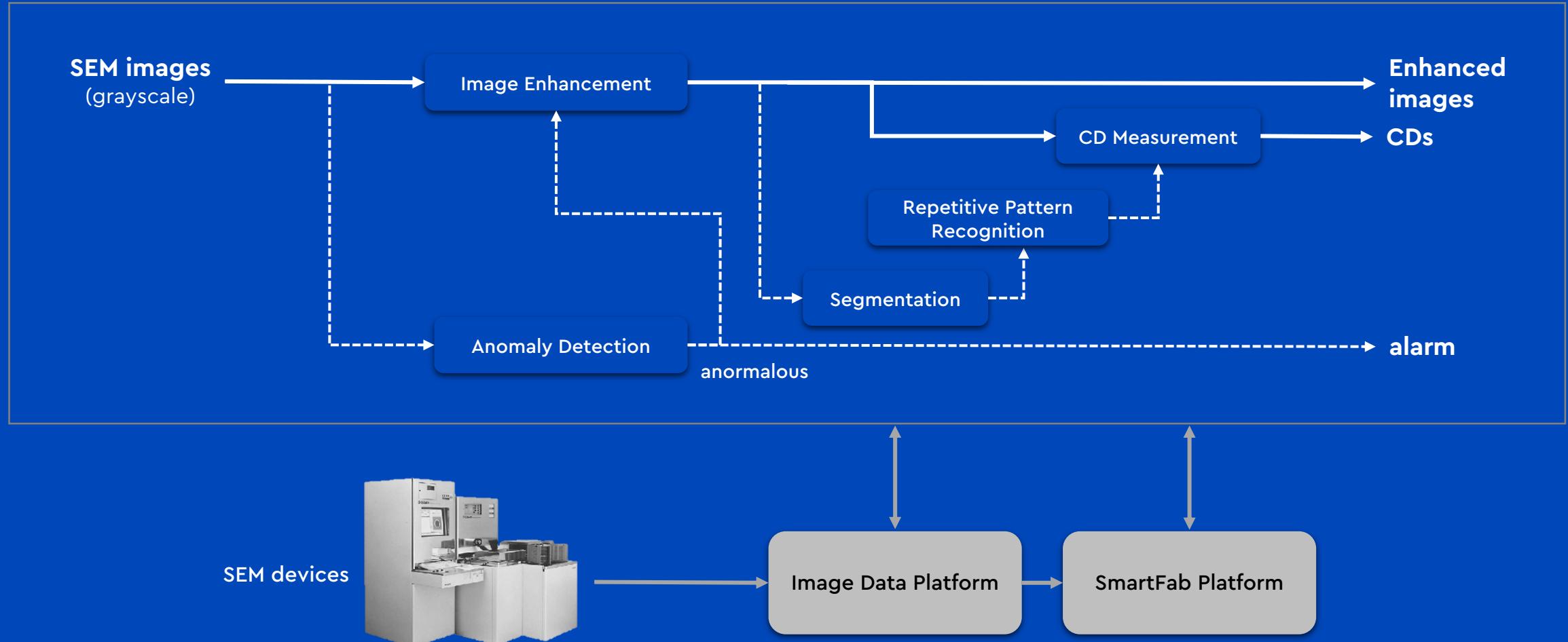


Extremely challenging!
<0.1 nm measurement precision guaranteed

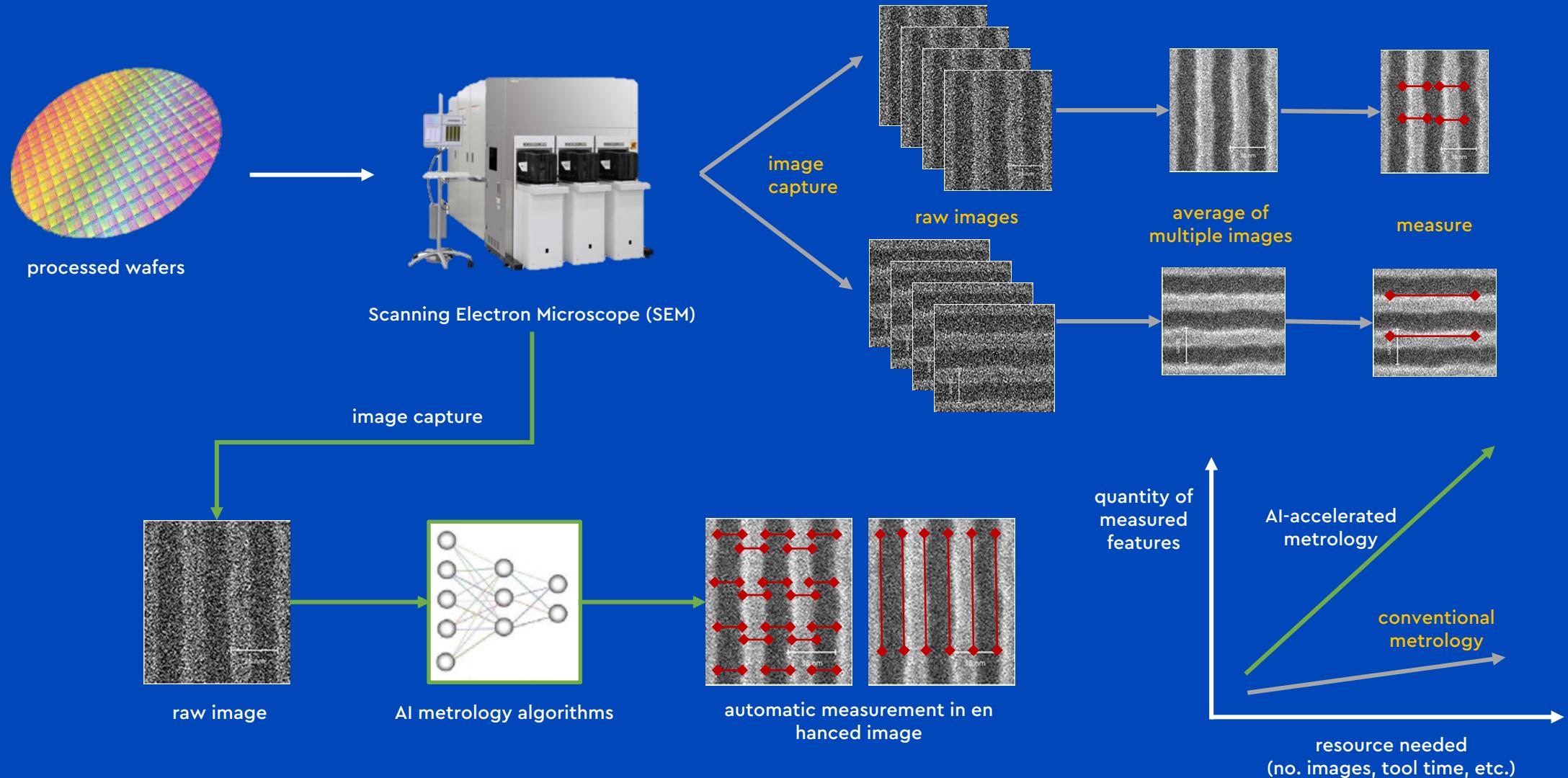
Anomaly detection in unsupervised learning



AI-accelerated metrology system



Automatic measurement for semiconductor manufacturing

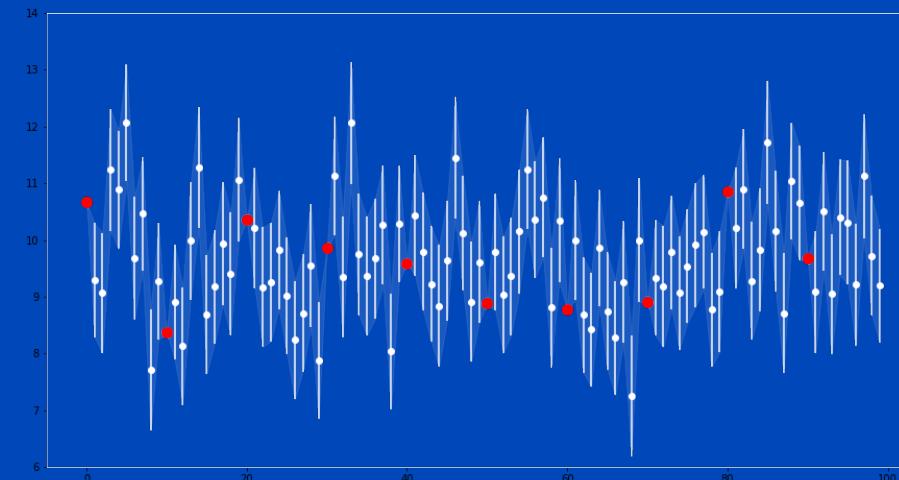
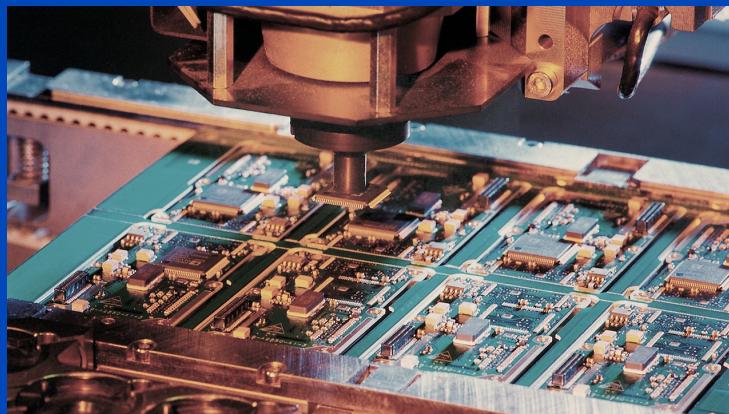


Time-series ML for manufacturing

Why time-series ML?

manufacturing application is about one of the followings:

- estimation of TS values - virtual metrology, yield prediction
- classification of TS values – predictive maintenance, recommendation system
- anomaly detection on TS - root cause analysis, root cause analysis for yield drop

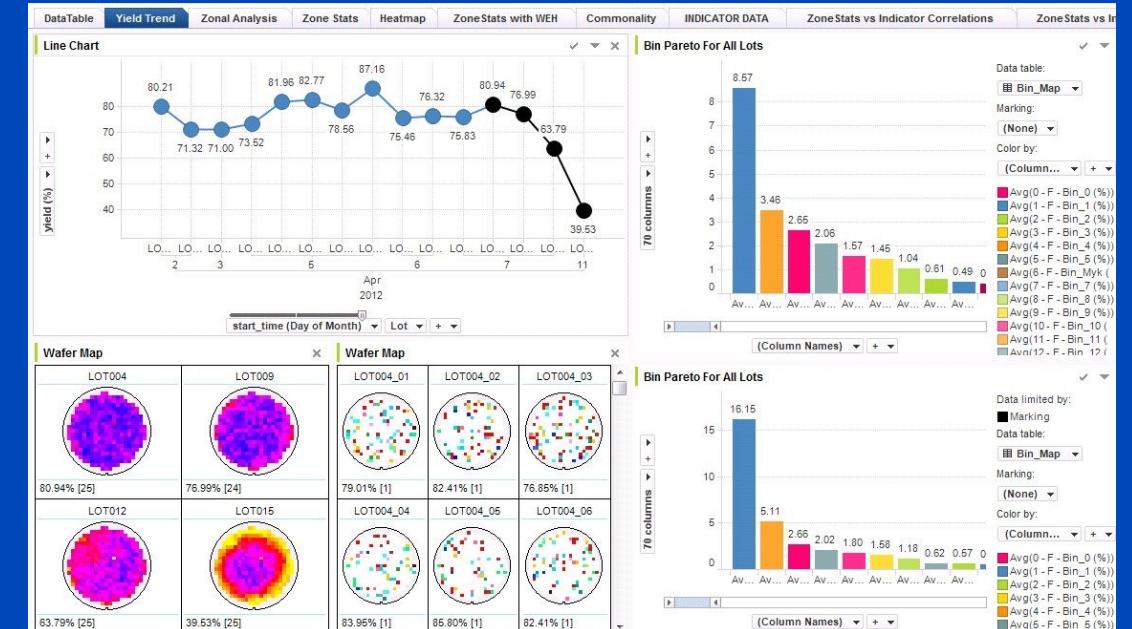


Difficulty & Advantage of TS ML

- *extremely difficult problems to solve*
- *(thus) not many researchers are interested*
 - *everyone's crazy about LLM, NLP, & CV*
- *all academic papers deal with easy (or synthesized) data*
- *almost no definition can exist for time-series data*
- *NONE of algorithms in papers worked*
- *100% home-grown data-specific application-tailored algorithms required*

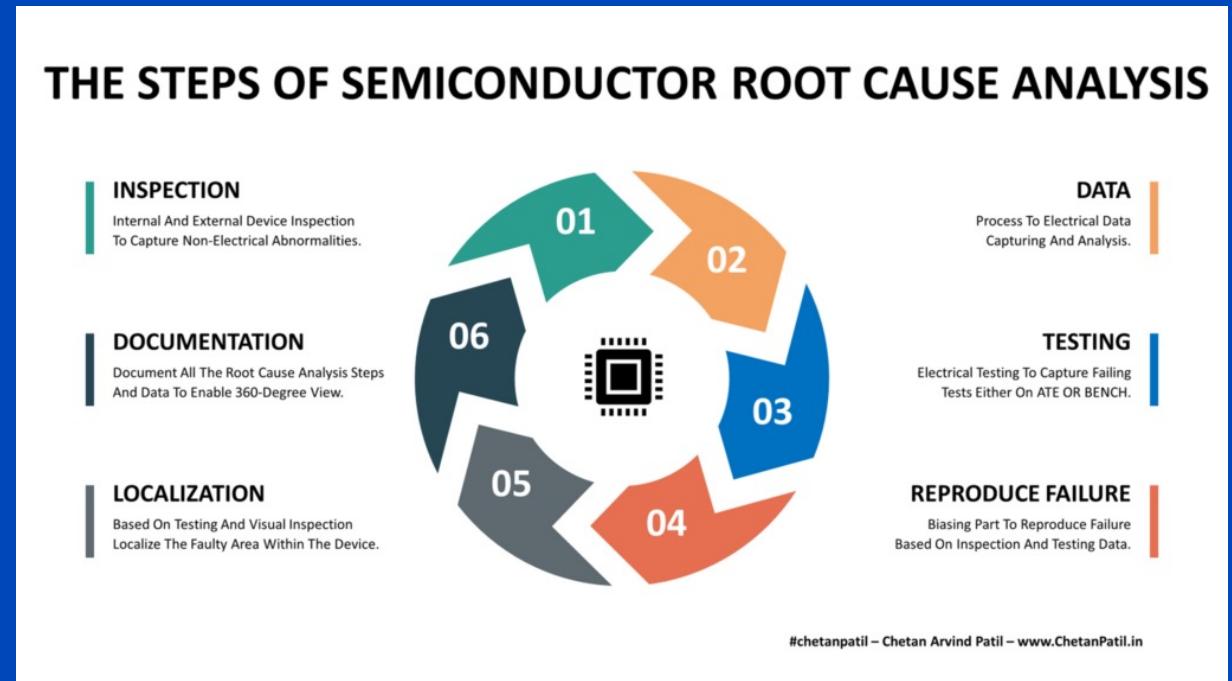
Time-series prediction & estimation

- virtual metrology
 - measure unmeasured processed materials using equipment sensor signals
 - business impacts
 - save investment on equipment, improve feedback control, SPC, yield improvement
- yield prediction
 - predict yield without waiting for fabrication to be finished
 - prevent wafer from being wasted
 - better product quality and larger profit, business impact



Root cause analysis & recommendation system

- equipment alarm root cause analysis
 - when *alarm goes off*, find responsible equipment and root causes
 - reduce equipment downtime, make *process engineers' lives easier*
- recommendation system
 - when *things go wrong*, provide recommendation for finding root cause
 - recommendation steps to following based on *history data*



Difficulties of Time-series ML

Data challenges

- covariate shift & concept drift

$\text{Prob}(x_{t_k}, x_{t_{k-1}}, x_{t_{k-2}}, \dots)$ *changes over time*

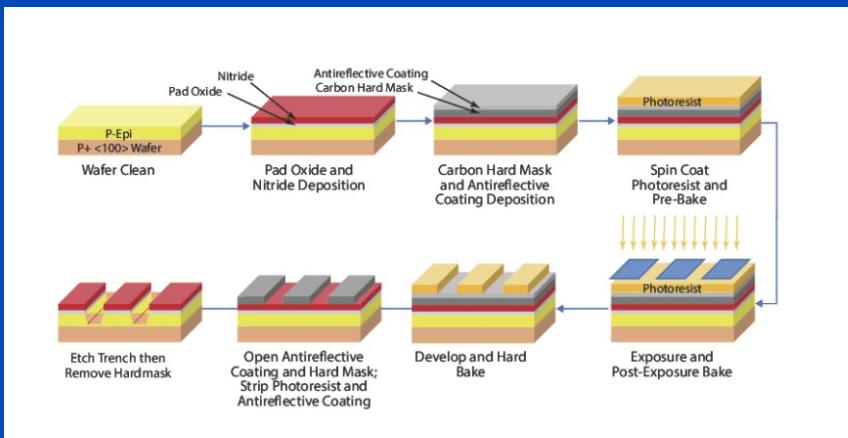
$\text{Prob}(y_{t_k} | y_{t_{k-1}}, y_{t_{k-2}}, \dots, x_{t_k}, x_{t_{k-1}}, x_{t_{k-2}}, \dots)$ *changes over time*

- fat data, *i.e.*, # features way larger than # data
- poor data quality; missing values, anomalies, wrong formats
- huge volume of data to process

Domain knowledge and fully home-grown algorithms

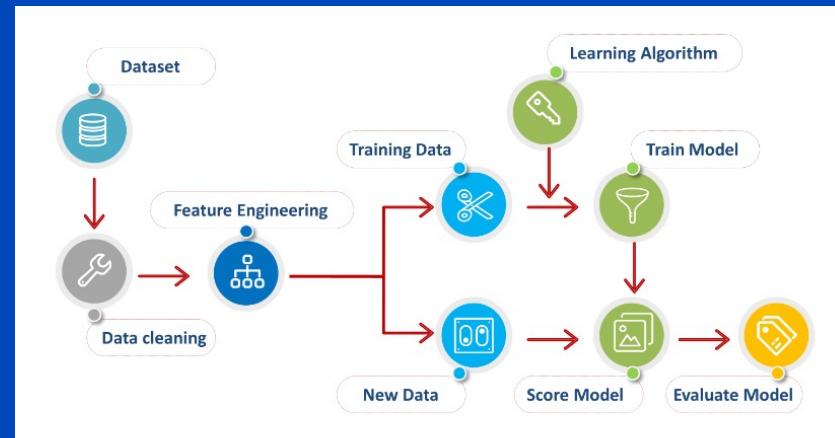
*in most cases,
domain knowledge is critical!*

close collaboration with customers required



*off-the-shelf algorithms
not working!*

developing fully customized algorithms needed



Virtual Metrology (VM)

What is VM?

*in many cases,
we cannot measure all
processed materials*

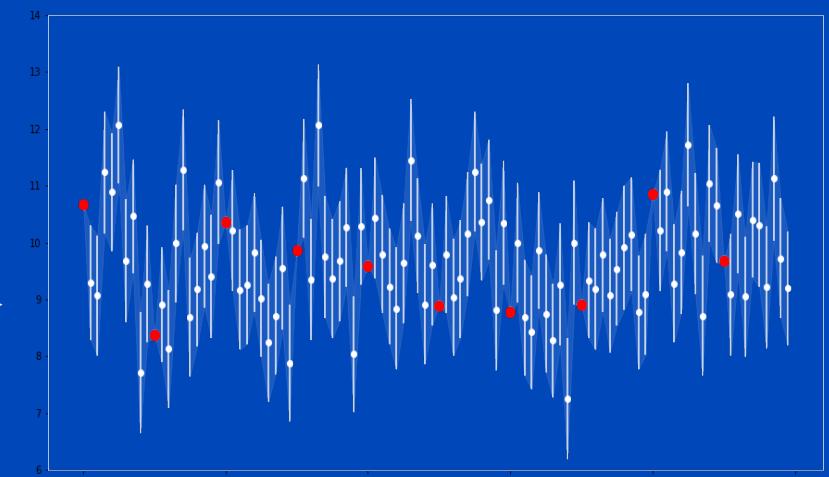
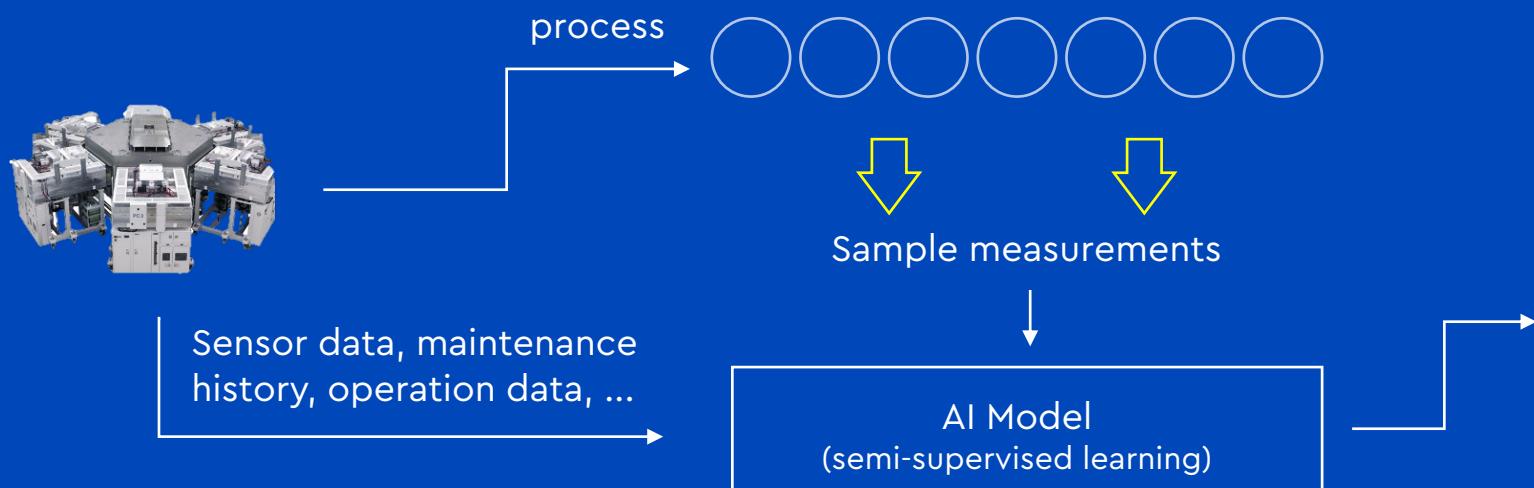
- measurement equipment too expensive
- full measuring hurts throughput

*thus, we do sampling
(with very low sampling rate)*

- average sampling rate is less than 5%

PROBLEM

- predict the measurement of unmeasured material using indirect signals
- sensor data, maintenance history, operation data, . . .



Business Impact made by VM

To the best of our knowledge

- no organization has even been (*this*) successful with VM

VM

- uses **home-grown AI model** to address with data drift/shift problems
- error **comparable to measurement equipment precision**
- provide **credibility intervals** of predictions - reliability information

VM implications

- virtually measuring **ALL wafers** – equivalent to investing on 100x measurement equipment
- enables optimal re-allocation of limited measurement resources

Conclusion

supervised / unsupervised / semi-supervised AIs required everywhere in industrial sectors

lots of agonizing challenges

huge changes potentially made via various applications

Impacts

- Tens of Millions of dollars by 1% yield increase
- 100x measurement equipment save by VM

THANK YOU